

MOS FIELD EFFECT TRANSISTOR **2SJ601**

SWITCHING P-CHANNEL POWER MOS FET

DESCRIPTION

The 2SJ601 is P-channel MOS Field Effect Transistor designed for solenoid, motor and lamp driver.

FEATURES

· Low on-state resistance:

 $R_{DS(on)1}$ = 31 $m\Omega$ MAX. (Vgs = $-10\,V,\ I_D$ = $-18\,A)$

 $R_{DS(on)2} = 46 \text{ m}\Omega \text{ MAX.} (V_{GS} = -4.0 \text{ V}, I_{D} = -18 \text{ A})$

· Low input capacitance:

 $C_{iss} = 3300 \text{ pF TYP.} (V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V})$

- · Built-in gate protection diode
- TO-251/TO-252 package

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

-	_		
Drain to Source Voltage (Ves = 0 V)	VDSS	-60	V
Gate to Source Voltage (VDS = 0 V)	Vgss	∓20	V
Drain Current (DC) (Tc = 25°C)	ID(DC)	∓36	Α
Drain Current (pulse) Note1	ID(pulse)	∓120	Α
Total Power Dissipation (Tc = 25°C)	Рт	65	W
Total Power Dissipation (T _A = 25°C)	Рт	1.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note2	las	– 35	Α
Single Avalanche Energy Note2	Eas	123	mJ

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

2. Starting T_{ch} = 25°C, V_{DD} = -30 V, R_G = 25 Ω , V_{GS} = -20 \rightarrow 0 V

★ ORDERING INFORMATION

PART NUMBER	PACKAGE
2SJ601	TO-251 (MP-3)
2SJ601-Z	TO-252 (MP-3Z)

(TO-251)



(TO-252)



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ELECTRICAL CHARACTERISTICS (TA = 25°C)

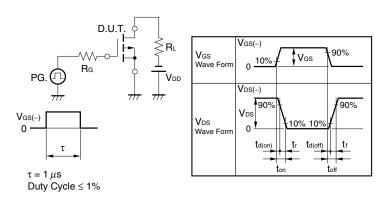
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V _{DS} = -60 V, V _{GS} = 0 V			-10	μΑ
Gate Leakage Current	Igss	V _{GS} = ∓20 V, V _{DS} = 0 V			∓10	μΑ
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = -10 V, I _D = -1 mA	-1.5	-2.0	-2.5	V
Forward Transfer Admittance Note	yfs	V _{DS} = -10 V, I _D = -18 A	15	30		S
Drain to Source On-state Resistance Note	R _{DS(on)1}	V _{GS} = -10 V, I _D = -18 A		25	31	mΩ
	R _{DS(on)2}	V _{GS} = -4.0 V, I _D = -18 A		32	46	mΩ
Input Capacitance	Ciss	V _{DS} = -10 V		3300		pF
Output Capacitance	Coss	V _{GS} = 0 V		580		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		230		pF
Turn-on Delay Time	t _{d(on)}	I _D = -18 A		11		ns
Rise Time	tr	V _{GS} = -10 V		12		ns
Turn-off Delay Time	td(off)	V _{DD} = -30 V		80		ns
Fall Time	t f	R _G = 0 Ω		53		ns
Total Gate Charge	Q _G	V _{DD} = -48 V		63		nC
Gate to Source Charge	Q _{GS}	V _{GS} = -10 V		10		nC
Gate to Drain Charge	Q _{GD}	I _D = −36 A		16		nC
Body Diode Forward Voltage Note	V _{F(S-D)}	I _F = 36 A, V _{GS} = 0 V		1.0		V
Reverse Recovery Time	t rr	I _F = 36 A, V _{GS} = 0 V		52		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		108		nC

★ Note Pulsed

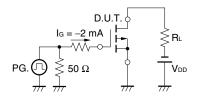
TEST CIRCUIT 1 AVALANCHE CAPABILITY

$V_{GS} = -20 \rightarrow 0 \text{ V}$ V_{DD} V_{DD}

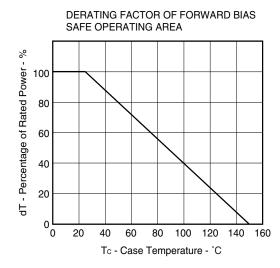
TEST CIRCUIT 2 SWITCHING TIME

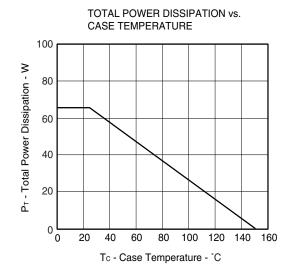


TEST CIRCUIT 3 GATE CHARGE

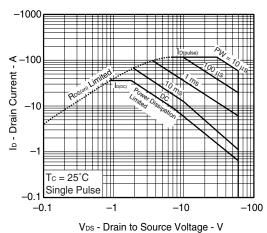


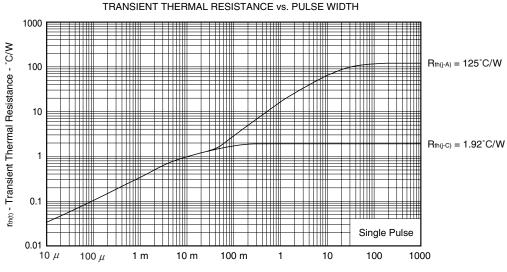
TYPICAL CHARACTERISTICS (TA = 25°C)





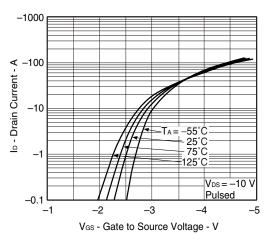
FORWARD BIAS SAFE OPERATING AREA

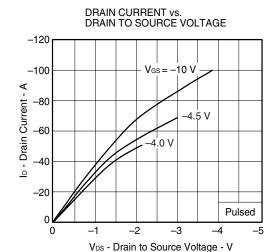




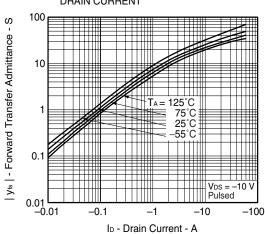
PW - Pulse Width - s

FORWARD TRANSFER CHARACTERISTICS

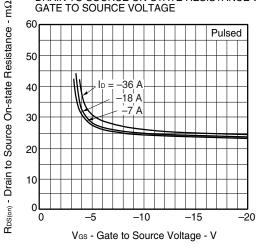




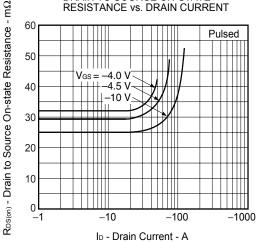
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



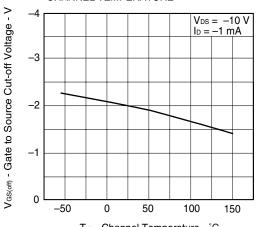
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



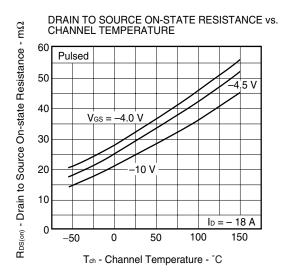
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

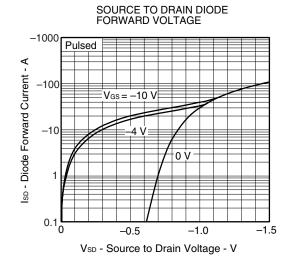


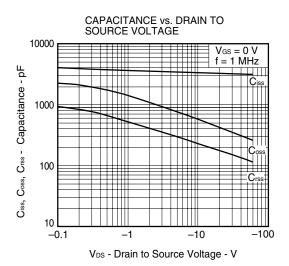
GATE TO SOURCE CUT-OFF VOLTAGE vs. **CHANNEL TEMPERATURE**

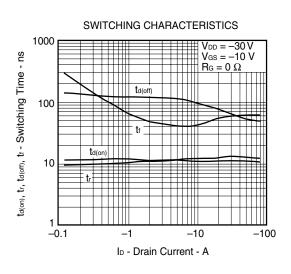


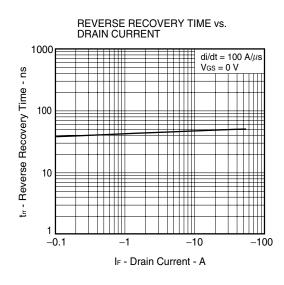
Tch - Channel Temperature - °C

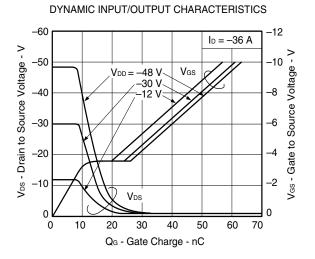


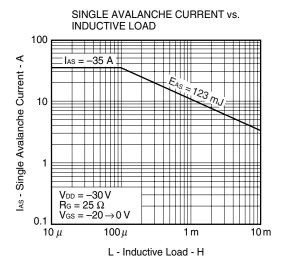


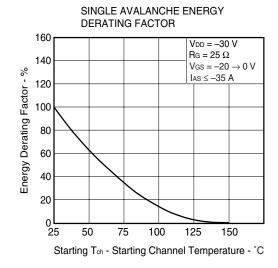




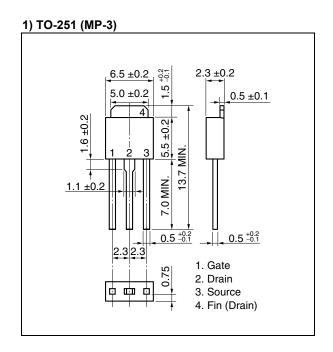


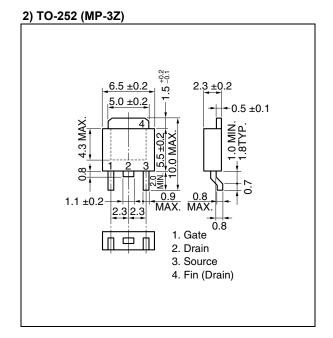




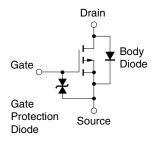


★ PACKAGE DRAWINGS (Unit: mm)





EQUIVALENT CIRCUIT



Remark The diode connected between the gate and source of the transistor serves as a protector against ESD.

When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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